

ROHM Op Amps: Pursuing a Completely Noiseless Design

Next-Generation Op Amp Series

Revolutionary noise design achieves refined operation featuring greater accuracy

2 Op Amps that pave the way to the sensing technology of tomorrow

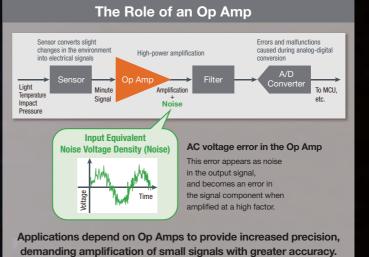
The importance of sensors continues to grow in the automotive and industrial equipment fields. Op Amps are essential for amplifying weak sensor signals, and achieving more accurate operation requires that the Op Amp itself have high immunity against EMI (electromagnetic interference) from external sources, and the Op Amp itself must not emit noise.

At ROHM, we have developed bipolar Op Amps for automotive use that minimizes the effects of EMI along with a CMOS Op Amp for industrial applications featuring the industry-low noise and breakthrough noise tolerance.

Development Background Increasing voltage amplification accuracy by suppressing noise

In recent years, the importance of and demand for sensors has risen due to advances in the field of automotive electronics, such as the introduction of ADAS (Advanced Driver Assist Systems). In addition, the use of IoT is rapidly expanding in the industrial equipment field. Advanced control utilizing sensors has become indispensable. In these areas, improving control accuracy and reducing power consumption are key issues, and peripheral circuits are being designed to operate at increasingly lower voltages.

Signals output from sensors are very small, making them susceptible to the effects of noise from surrounding electronic and communications equipment. This often causes noise to be amplified with the input signal, increasing the possibility of erroneous recognition that can lead to malfunctions. At the same time, to achieve high accuracy voltage amplification it is extremely important that the Op Amp itself does not generate noise. In response, leveraging considerable expertise allowed ROHM to develop automotive-grade Op Amps featuring high EMI tolerance that eliminates the needs for noise designs as well as models that provide unprecedented* noise performance ideal for industrial equipment.

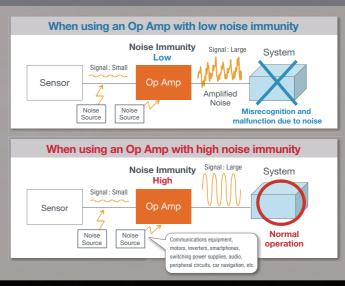


Technical Background Development system integrating design and manufacturing

ROHM utilizes a comprehensive production system that integrates all processes, from product planning and circuit design to layout, prototype evaluation and test development. In the development of these 2 types of Op Amps, the development process covering circuit design and element layout is carried out in seamless cooperation with the product process (i.e. packaging), taking into consideration element form and materials. Conducting a thorough review of each process and optimally combining remedial measures allowed ROHM to develop Op Amps with exceptionally high EMI immunity as well as a CMOS op amp that provides the lowest*noise in the industry.

Factors considered during the development process									
Circuit des	ign: Element characteristics, power supply fluctuations, signal level, etc.								
Layout :	Element arrangement, pair characteristics, signal interference, etc.								
Factors considered during the manufacturing process									
Wafer :	Element shape, element materials, wiring materials, etc.								
Package:	Heat dissipation characteristics, frame materials, wire materials, etc.								

Rising demand for better noise performance following the increasing density and electrification of automotive systems



Ultra Low Noise Op Amp

Ultra-High EMI Immunity

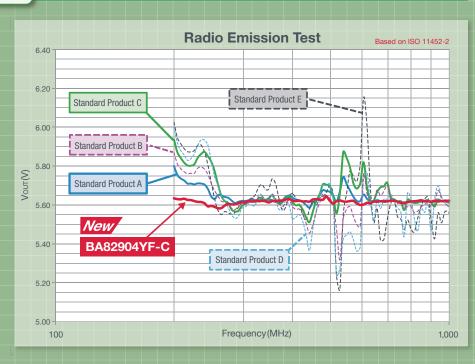
High EMI Immunity Op Amp



EMI Immunity Op Amp
BA82904YF-C

Industry-leading* noise immunity

As shown in the graph of the output voltage fluctuation at different noise frequencies at right, in contrast to the measured peaks of standard products A to E that are easily affected by frequency-based noise, ROHM's new product minimizes fluctuations based on frequency, making it possible to limit output voltage variations to less than ±1% (vs ± 3.5 to $\pm 10\%$ with standard products). Achieving high EMI immunity greatly reduces the burden placed on designers of automotive electrical systems to develop noise countermeasures that typically require much time and effort. This reduces the cost and space previously required for external components such as the CR filter and shielding



significantly reduces the design load for countermeasures against noise

Ultra-Low Noise

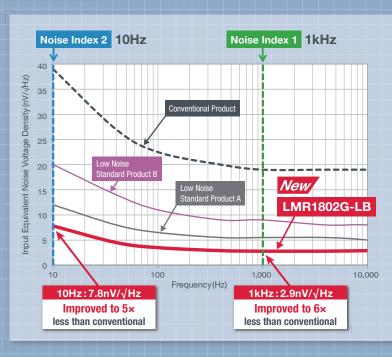
Low-Noise CMOS Op Amp

Ultra Low Noise Op Amp

Achieving greater accuracy through the industry's lowest* noise

To meet the increasing need for high accuracy sensor control, ROHM developed a CMOS Op Amp that significantly reduces the noise generated within the Op Amp itself. Typically, noise generated by the internal transistors and resistors can cause errors during signal amplification, which can degrade amplification accuracy. In response, ROHM improved both the circuit design and manufacturing processes to achieve the lowest* noise in the industry, as shown in the graph at right. As a reference, 2.9nV/√Hz is approx. 6× less than the conventional value, while 7.8 nV/ \sqrt{Hz} is 5× less. In addition, the new design suppresses the input bias current and input offset voltage (that are sources of error during amplification) while improving the phase margin of the oscillation margin (which is in a trade-off relationship with conventional noise) to an industry-best 68°. The result is not only lower noise, but significantly greater accuracy and operational stability as well. These improvements make it possible to design a

peripheral circuit that can maximize sensor performance.



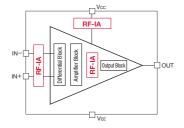
Significantly improving noise immunity by conducting a thorough review of circuits, layout, element size, and other factors

ROHM thoroughly analyzed previous products, added noise countermeasures circuits, reviewed the layout, and selected processes that generate optimal capacitances to dramatically improve EMI immunity. The key to success was to utilize a flexible approach in selecting the optimum solution, rather than

simply following the industry trend of reducing chip size. This breakthrough noise immunity could never be achieved with just one countermeasure, but was instead the culmination of 3 factors.

Circuit review

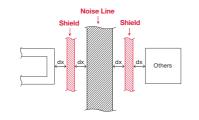
Noise tolerance is improved by incorporating a newly developed noise countermeasure circuit RF-IA in required locations.





Layout review

In addition to reviewing wiring interference. shields were placed in the noise line and the impedance of the internal analog core adjusted.

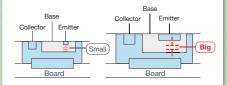


1 Noise Line Shield

- 2 Review of Wiring Interference **③ Impedance Adjustment of Internal**
 - Analog Core

Utilizing optimized processes

Focusing on fact that the noise immunity is high when the parasitic capacitance is large made it possible to select the process and element size that will result in the ideal parasitic capacitance.



Parasitic capacitance differs based on process and element size

Process that yielded the ideal parasitic capacitance selected

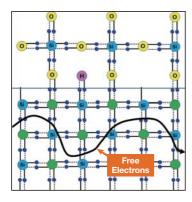
EMI noise immunity is improved when the above 3 measures are fully aligned

Achieving the lowest* noise in the industry by combining aspects of both circuit design and the production process

An analysis of ROHM's previous low-noise Op Amps was conducted from the standpoint of the manufacturing process. As a result, it was discovered that minimizing electron scattering due to impurities makes it possible to suppress flicker noise. This significantly improves noise characteristics in the low frequency band. In addition, by adjusting the size of the transistor and circuit structure and decreasing the resistance value, ROHM was able to reduce

thermal noise (white noise) generated from the internal transistors, resistors, and wiring. The key to achieving lower noise was approaching this challenge from both manufacturing and design aspects, allowing ROHM to deliver the lowest* noise characteristics on the market which would not be possible otherwise. The advantages of ROHM's vertically integrated production system are on full display here as well.

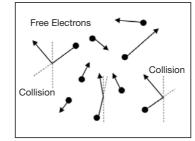
Improvements through the manufacturing process



Flicker noise

Flicker noise is believed to be caused by the scattering (fluctuation) of electrons due to impurities contained within the semiconductor. Therefore, suppressing electron scattering within the semiconductor will cause the electrons to flow more smoothly.

Improvements through circuit design



Thermal noise

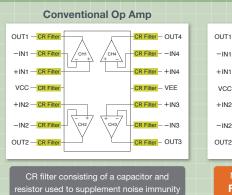
Thermal noise occurs in the internal resistance components, pure resistors, transistors, wiring, and other elements. Improvements are achieved by reducing the resistance value and optimizing the circuit configuration and transistor size.

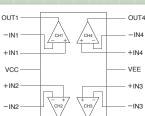
Significantly reducing the time, effort, and costs

for noise countermeasures

Breakthrough EMI noise immunity eliminates the need for an external CR filter and shield previously required, contributing to greater space savings while reducing peripheral component costs.

Also, previously when integrating noise countermeasures, if noise evaluation fails after implementing functional and noise designs, it was necessary to start from the beginning, placing a considerable burden in terms of time, effort, and cost. In response, ROHM's new Op Amp allows users to significantly reduce design man-hours and costs, contributing to shorter delivery times for set design.





ROHM's New Product

Facilitates noise design

OUTS

Provides superior versatility and complies with

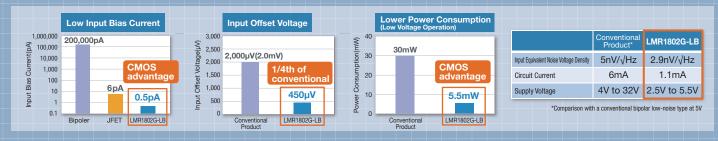
international standards for reliability

ROHM's new high EMI immunity Op Amp maintains the same performance as conventional products, ensuring worry-free operation even when used as a replacement. In addition, qualification under the international automotive standard AEC-Q100 ensures superior reliability.

	When designing a new	model(boa	ird)							
	For a Conventional Op Am)	Possibility of	of failure)					
	Functional Design Noise Countermeasure Design Set FAE	Set Evaluation	Noise Evaluation N	oise Counterme: Redesign	sure Set FAB	Set Evaluation	Noise Evaluation			
Designing noise countermeasures is extremely difficult Noise Evaluation Site(Location) Noise Evaluation Usage fee : Approx. 500,000 yen/day Usage fee : Approx. 500,000 yen/day Usage fee : Approx. 500,000 yen/day										
	For ROHM's New Op Amp Functional Design Set FAB Set Evalue	tion Noise Evaluation		lc	ad and desig					
	Less time spent on designing noise counte	rmeasures Pas	ne	Enables quick response for sets requiring short delivery times						

Significantly reduces input bias current and input offset voltage

The main cause of input bias current is said to be element leakage current that prevents damage caused by static electricity, but by optimizing the element size ROHM was able to limit the current to 0.5pA (around half that of conventional models). For input offset voltage, ROHM conducted a review of the circuit design in order to increase voltage gain and minimized the effects of device variations by increasing the transistor element size. Furthermore, selecting a production process that can optimize the input offset voltage is another factor allowing ROHM to achieve a low value of 450μ V (1/4th of conventional).

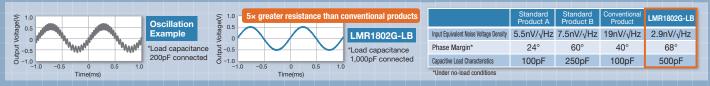


Improved phase margin

ensures superior stability

The 3rd feature is excellent stability. One problem with conventional Op Amps is that the phase margin becomes smaller as noise is reduced, increasing the likelihood of oscillation. ROHM's new product achieves a high phase margin of 68° through optimized phase compensation integrated into several areas

in the circuit in order to suppress oscillation. In addition, the capacitive load characteristics which is an indicator of how easily oscillation can occur has been raised to 500pF.



Product Lineup

Automotive-Grade Ground Sense Op Amps Featuring High EMI Immunity

Ideal for impedance conversion and amplifying weak signals

Optimized for high-voltage circuits, including engine ECUs and EVs

	Part No.	No. of ch	Supply Voltage (V)	Circuit Current (mA)	Input Offset Voltage (mV)	Input Bias Current (nA)	Output Current (mA)	Input Voltage (V)	Output Voltage (V)	Voltage Gain (dB)	CMRR (dB)	PSRR (dB)	Slew Rate (V/µs)	Gain Bandwidth Product (MHz)	Operating Temperature (°C)	Package
Ne	W BA82904YF-C	2	3 to 36	0.5	2.0	20	30	VEE to	V _{EE} to	100	80	100	0.2	0.5	-40 to +125	SOP8
Ne	BA82904YFVM-C	2	3 10 30	0.5	2.0	20	30	Vcc-1.5	Vcc-1.5	100	00	100	0.2	0.5	-40 10 1 123	MSOP8
Ne	W BA82902YF-C		3 to 36	0.7	0.0	00	20	VEE to	VEE to	100	00	100	0.0	0.5	-40 to +125	SOP14
Ne	BA82902YFV-C	4	3 10 30	0.7	2.0	20	30	Vcc-1.5	Vcc-1.5	100	80	100	0.2	0.5	-40 10 + 125	SSOP-B14

Automotive-Grade Ground Sense Op Amps

Part No.	No. of ch	Supply Voltage (V)	Circuit Current (mA)	Input Offset Voltage (mV)	Input Bias Current (nA)	Output Current (mA)	Input Voltage (V)	Output Voltage (V)	Voltage Gain (dB)	CMRR (dB)	PSRR (dB)	Slew Rate (V/µs)	Gain Bandwidth Product (MHz)	Operating Temperature (°C)	Package
BA2904YF-C															SOP8
BA2904YFV-C	2	3 to 36	0.5	2.0	20	30	V _{EE} to V _{CC} –1.5	V _{EE} to V _{CC} –1.5	100	80	100	0.2	0.5	-40 to +125	SSOP-B8
BA2904YFVM-C															MSOP8
BA2902YF-C	4	3 to 36	0.7	2.0	20	30	V_{EE} to	V _{EE} to	100	80	100	0.2	0.5	-40 to +125	SOP14
BA2902YFV-C	4	3 10 30	0.7	2.0	20	30	Vcc-1.5	Vcc-1.5	100				0.5		SSOP-B14
BA2904YF-M			0.5	2.0	20	30	V _{EE} to V _{CC} -1.5	V _{EE} to Vcc−1.5	100	80	100	0.2		-40 to +125	SOP8
BA2904YFV-M	2	3 to 36											0.5		SSOP-B8
BA2904YFVM-M															MSOP8
BA2902YF-M	4	0.44.00	0.7	0.0	00	00	V _{EE} to	V _{EE} to	100	00	100	0.0	0.5	40 to 1 105	SOP14
BA2902YFV-M	4	3 to 36	0.7	2.0	20	30	Vcc-1.5	Vcc-1.5	100	80	100	0.2	0.5	-40 to +125	SSOP-B14

Low-Noise CMOS Op Amp

	Part No.	Io. No. of Circuits		Input Equivalent Noise Voltage Density (nV/ _V /Hz)	Phase Margin (°)	Capacitive Load Characteristics (pF)	Input Bias Current (pA)	Input Offset Voltage (mV)	Operating Temperature (°C)	Package (mm)
New	LMR1802G-LB	LMR1802G-LB 1 2.5 to 5.5		2.9(1kHz) 7.8(10Hz)	68*	500	0.5	0.45	-40 to +125	SSOP5 (2.9×2.8×1.25)
										*Under no-load conditions

1) The information contained in this document is current as of October, 2018.

2) The information contained herein is subject to change without notice. Before you use our Products, please contact our sales representative (as listed below) and verify the latest specifications.

3) Although ROHM is continuously working to improve product reliability and quality, semiconductors can break down and malfunction due to various factors. Therefore, in order to prevent personal injury or fire arising from failure, please take safety measures such as complying with the derating characteristics, implementing redundant and fire prevention designs, and utilizing backups and fail-safe procedures. ROHM shall have no responsibility for any

damages arising out of the use of our Products beyond the rating specified by ROHM. 4) Examples of application circuits, circuit constants and any other information contained herein are provided only to illustrate the standard usage and operations of the Products. The peripheral conditions must be taken into account

when designing circuits for mass production.

5) The technical information specified herein is intended only to show the typical functions of and examples of application circuits for the Products. ROHM does not grant you, explicitly, any license to use or exercise intellectual property or other rights held by ROHM or any other parties. ROHM shall have no responsibility whatsoever for any dispute arising out of the use of such technical information.

6) The Products are intended for use in general electronic equipment (i.e. AV/OA devices, communication, consumer systems, gaming/entertainment sets) as well as the applications indicated in this document.

7) The Products specified in this document are not designed to be radiation tolerant.

8) For use of our Products in applications requiring a high degree of reliability (as exemplified below), please contact and consult with a ROHM representative: transportation equipment (i.e. cars, ships, trains), primary communication equipment, traffic lights, fire/crime prevention, safety equipment, medical systems, servers, solar cells, and power transmission systems

9) Do not use our Products in applications requiring extremely high reliability, such as aerospace equipment, nuclear power control systems, and submarine repeaters.

10) ROHM shall have no responsibility for any damages or injury arising from non-compliance with the recommended usage conditions and specifications contained herein.

11) ROHM has used reasonable care to ensure the accuracy of the information contained in this document. However, ROHM does not warrant that such information is error-free and ROHM shall have no responsibility for any damages arising from any inaccuracy or misprint of such information.

12) Please use the Products in accordance with any applicable environmental laws and regulations, such as the RoHS Directive. For more details, including RoHS compatibility, please contact a ROHM sales office as listed below. ROHM shall have no responsibility for any damages or losses resulting non-compliance with any applicable laws or regulations.

13) When providing our Products and technologies contained in this document to other countries, you must abide by the procedures and provisions stipulated in all applicable export laws and regulations, including without limitation the US Export Administration Regulations and the Foreign Exchange and Foreign Trade Act.

14) This document, in part or in whole, may not be reprinted or reproduced without prior consent of ROHM.

ROHM	Sales Office	es Co	ontact us for furthe	r informatio	n about the produ	ucts.					
Santa Clara	+1-408-720-1900	Stuttgart	+49-711-7272370	Dalian	+86-411-8230-8549	Malaysia	+60-3-7931-8155				
Atlanta	+1-770-754-5972	Nuremberg	+49-911-810452-26	Beijing	+86-10-8525-2483	India	+91-80-4125-0811				
Boston	+1-781-565-1138	France +	33 (0) 1 40 60 87 30	Shanghai	+86-21-6072-8612	Kyoto	+81-75-365-1077	ROHM Co.,Ltd.			
Chicago	+1-847-368-1006	United Kingdom	+44-1-908-272400	Shenzhen	+86-755-8307-3008	Yokohama	+81-45-476-2121		RUP		
Detroit	+1-248-348-9920	Finland	+358-400-726 124	Hong Kong	+852-2740-6262			21 Saiin Mizosaki-cho, Ukyo-ku,			
San Diego	+1-858-625-3600	Spain	+34-9375-24320	Taiwan	+886-2-2500-6956			Kyoto 615-8585 Japan TEL : +81-75-311-2121 FAX : +81-75-315-0172	SEMICOND		
Mexico	+52-33-3123-2001	Hungary	+36-1-950-5859	Singapore	+65-6436-5100			TEL: +01-75-311-2121 FAX: +01-75-315-0172	Schreont		
Brazil	+55-11-3539-6320	Italy	+39-039-5783432	Philippines	+63-2-807-6872			www.robro.com			
Germany	+49-2154-921-0	Seoul	+82-2-8182-700	Thailand	+66-2-254-4890			www.rohm.com			
Catalog No.61X7167E-B 11.2018 ROHM © 3000IS											



истов